## **CLAIMS**

1. A low-gluten wafer comprising:

about one part wheat starch,

about one part pre-gelatinized wheat starch, where the wheat starch and the pregelatinized wheat starch are combined to form a first substantially homogeneous mixture, and

about two parts water, where the water has a temperature of between about 100 degrees Fahrenheit and about 150 degrees Fahrenheit, said water added to said first substantially homogeneous mixture to create a substantially homogeneous pre-cooked mixture, where between about 1/20<sup>th</sup> of a teaspoon to about 1/2 of the pre-cooked mixture are heated to a temperature between about 250 degrees Fahrenheit to about 400 degrees Fahrenheit for between about 5 minutes to about 10 minutes.

- 2. The low-gluten wafer according to claim 1 wherein, the wafers, after heating, are cooled to about room temperature.
- 3. The low-gluten wafer according to claim 2 wherein the wafers are stored in an airtight environment.
- 4. The low-gluten wafer according to claim 1 wherein the wafers, after heating, are cooled to temperatures below about 32 degrees Fahrenheit
- 5. The low-gluten wafer according to claim 1, where the water has a temperature of about 125 degrees Fahrenheit
- 6. A method of making a low-gluten wafer comprising the steps of:

combining about one part wheat starch with about one part pre-gelatinized wheat starch into a first substantially homogeneous mixture,

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adding water to the first homogenous mixture where the water has a temperature between about room temperature and about 212 degrees Fahrenheit degrees until the combination of water and the first substantially homogeneous mixture create a substantially homogeneous precooked mixture,

sheeting portions of the pre-cooked mixtures of about between 1/20<sup>th</sup> of a teaspoon to about 1/2 of a teaspoon onto a cooking surface having a temperature between about 250 degrees Fahrenheit and about 350 degrees Fahrenheit, and

cooking said portions for about 5 minutes to 10 minutes.

- 7. The method according to claim 6, where the sheeting step further includes shaping the portions of the pre-cooked homogeneous mixture into wafers having a diameter of about 1.0 inch to about 3.5 inches.
- 8. The method according to claim 7, where the cooking surface may include two parallel heated plates where said portion of the pre-cooked homogeneous is sheeted between the parallel plates.
- 9. The method according to claim 7, further comprising the step of cooling the wafers to a temperature between about 32 degrees Fahrenheit to room temperature.
- 10. The method according to claim 7, further comprising the step of cooling the wafers to a temperature below about 32 degrees Fahrenheit.
- 11. A low gluten wafer having a pre-cooked mixture composition of about 25 % by weight wheat starch, about 25 % by weight pre-gelatinized wheat starch, and about 50% water, where said water has a temperature between about room temperature to about 212 degrees Fahrenheit, where the wheat starch and pre-gelatinized wheat starch are first combined into a substantially

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homogeneous mixture and the water is then added and mixed to create a substantially homogeneous precooked mixture.

12. The low gluten wafer according to claim 11 where the water has a temperature of about 125 degrees Fahrenheit.

13. A low-gluten wafer comprising:

about 2 tablespoons of pre-gelatinized wheat starch, about 2 tablespoons of pre-gelatinized wheat starch, and about ½ cup of water.

3 Claims